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High Performance Schottky Rectifier, 1.0 A



SMB (DO-214AA)

PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V_{R}	30 V			
V _F at I _F	0.30 V			
I _{RM} max.	20 mA at 125 °C			
T _J max.	125 °C			
E _{AS}	3.0 mJ			
Package	SMB (DO-214AA)			
Circuit configuration	Single			

FEATURES

- Small foot print, surface mountable
- Very low forward voltage drop

• High frequency operation

RoHS COMPLIANT HALOGEN

- Guard ring for enhanced ruggedness and long FREE term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION / APPLICATIONS

The VS-MBRS130L-M3 surface mount Schottky rectifier has been designed for applications requiring low forward drop and small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS		
I _{F(AV)}	Rectangular waveform	1.0	Α		
V _{RRM}		30	V		
I _{FSM}	t _p = 5 μs sine	230	А		
V _F	1.0 A _{pk} , T _J = 125 °C	0.30	V		
TJ	Range	-55 to +125	°C		

VOLTAGE RATINGS				
PARAMETER	SYMBOL	VS-MBRS130L-M3	UNITS	
Maximum DC reverse voltage	V _R	30	V	
Maximum working peak reverse voltage	V_{RWM}	30	V	

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I _{F(AV)}	50 % duty cycle at T _L = 112 °C, rectangular waveform		1.0	
Maximum peak one cycle		5 µs sine or 3 µs rect. pulse	Following any rated load	230	Α
non-repetitive surge current	I _{FSM}	10 ms sine or 6 ms rect. pulse	condition and with rated V _{RRM} applied	40	
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 1 \text{A}, L = 6 \text{mH}$		3.0	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		1.0	Α



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ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
	V _{FM} ⁽¹⁾	1 A	T _J = 25 °C	0.420	
Maximum forward voltage drop		2 A	11 = 23 0	0.470	V
Maximum forward voltage drop		1 A	T _J = 125 °C	0.300	
		2 A		0.370	
Maximum reverse leakage current	I _{RM} ⁽¹⁾	T _J = 25 °C	V _R = Rated V _R	1	
		T _J = 100 °C		10	mA
		T _J = 125 °C		20	
Maximum junction capacitance	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		200	pF
Typical series inductance	L _S	Measured lead to lead 5 mm from package body		2.0	nH
Maximum voltage rate of change	dV/dt	Rated V _R 10 000		V/µs	

Note

 $^{(1)}$ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction temperature range	T _J ⁽¹⁾		-55 to +125	°C
Maximum storage temperature range	T _{Stg}		-55 to +150	C
Maximum thermal resistance, junction to lead	R _{thJL} (2)	DC operation See fig. 4	25	°C/W
Maximum thermal resistance, junction to ambient	R_{thJA}	DC operation	80	C/VV
Approximate weight			0.10	g
Approximate weight			0.003	oz.
Marking device		Case style SMB (DO-214AA)	13	BL

Notes

(1) $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$ thermal runaway condition for a diode on its own heatsink

(2) Mounted 1" square PCB

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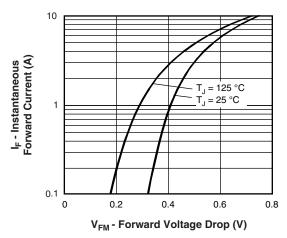


Fig. 1 - Maximum Forward Voltage Drop Characteristics

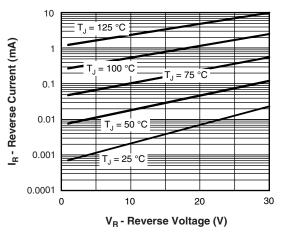


Fig. 2 - Typical Peak Reverse Current vs. Reverse Voltage

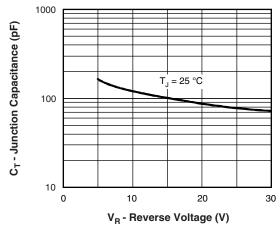
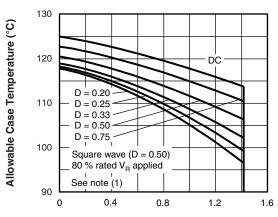
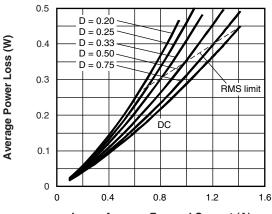


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage



I_{F(AV)} - Average Forward Current (A)

Fig. 4 - Maximum Average Forward Current vs. Allowable Lead Temperature



I_{F(AV)} - Average Forward Current (A)

Fig. 5 - Maximum Average Forward Dissipation vs. Average Forward Current

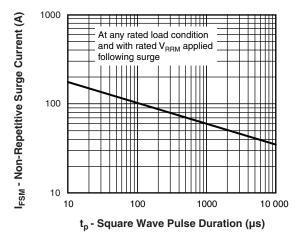


Fig. 6 - Maximum Peak Surge Forward Current vs. Pulse Duration

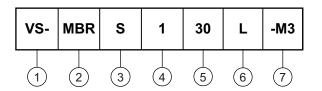
Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; $Pd = forward power loss = I_{F(AV)} \times V_{FM} at (I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = inverse power loss = V_{R1} \times I_R (1 - D)$; I_R at $V_{R1} = 80 \%$ rated V_R

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ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product
- 2 Schottky MBR series
- 3 S = SMB
- 4 Current rating (1 = 1 A)
- 5 Voltage rating (30 = 30 V)
- 6 L = low forward voltage
- 7 M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	PREFERRED PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-MBRS130L-M3/5BT	5BT	3200	13" diameter plastic tape and reel		

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95401			
Part marking information	www.vishay.com/doc?95403			
Packaging information	www.vishay.com/doc?95404			



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SMB

DIMENSIONS in inches (millimeters)

DO-214AA (SMB)



Mounting Pad Layout





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